Marking on device: VS1033D
PPP PPP PPP PPP
YYWW
where, PPP PPP PPP PPP = Lot ID
YYWW = assembly Year and Week > 0932

**Lead Frame**

- plate composition 100% Sn
- plate thickness 0.5 +/- 0.05 mils

**Material**

- Lead Frame: Olin C7025
- Epoxy Die Attach: CRM 1076 NS
- Bonding Wire: 1.0 mil Au
- Mold Compound: EME G700LX